

QLSP23A V1.0 (0402 Amber LED)





Product Outline:

SMD LED lamps from Quelighting are available in miniature sizes and special configurations for automated PC board assembly and space-sensitive applications. These SMD LED lamps are suitable for use in a wide variety of electronic equipment, including cordless and cellular phones, notebook computers, network systems, home appliances, and indoor signboard applications.

Features:

- Compatible with automatic placement equipment.
- RoHS compliant
- Package Dimension = 1.0mmX0.55mmX0.48mm (0402 package)
- Compatible with infrared and vapor phase reflow solder process.
- Custom Bin available upon special request

Application:

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.
- Microdisplays

Compliance and Certification:

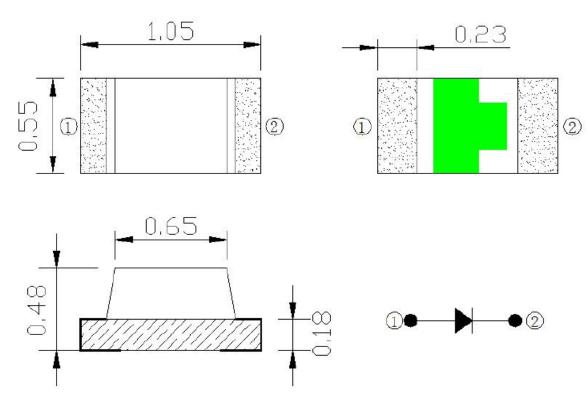






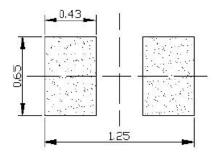


Mechanical Property: (Dimension)



- * All dimensions are in millimeters,
- * Tolerances are ± 0.10mm.

Recommended Solder footprint:



- * All dimensions are in millimeters.
- * Reflow soldering must not be performed more than twice.





Characteristics

■ Absolute Maximum Ratings

(Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	V_{R}	5	V
DC Forward Current	If	25	mA
Pulse Forward Current (Duty 1/10 @1KHz)	 FP	60	mA
Total Power Dissipation	Pd	55	mW
Electrostatic Discharge (HBM)	ESD	2000	V
Storage Temperature	Tstg	-40 ~ 85	$^{\circ}$
Operation Temperature	Topr	-40 ~ 85	$^{\circ}$
Soldering Temperature	Tsol	260 < 10 sec	°C

⁽¹⁾ Proper current rating must be observed to maintain junction temperature below maximum at all time

■ Electrical / Optical Characteristic

(Ta=25 oC)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	71.5		180.0	mcd	
Peak Wavelength	λр		606		nm	
Dominant Wavelength	λd	600		610	nm	I=20mA
Forward Voltage	Vf	1.9		2.3	V	
View Angle	θ		120		deg	

- (1). Tolerance of Luminous Intensity: ±11%
- (2). Tolerance of Dominant Wavelength ±1nm
- (3). Tolerance of measurement: VF=+/- 0.1V





■ Groups

Forward Voltage (V_F) Bin:

VF Rank (V)				Condition
Color	Code name	Low	High	unit
	Q	1.9	2.0	
Amber	R	2.0	2.1	IF 20m A
	S	2.1	2.2	
	Т	2.2	2.3	IF=20mA

Luminous Intensity Bin:

	Rank (mcd)			
Color	Code name	Low	High	Unit
	Q	71.5	112.5	
Amber	R	112.5	180	IF=20mA

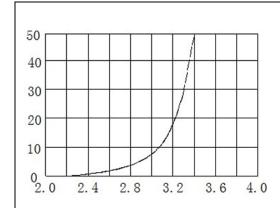
Dominant Wavelength Bin:

	Condition			
Color	Code name	Low	High	Unit
	A4	600	605	
Amber	A5	605	610	IF=20mA





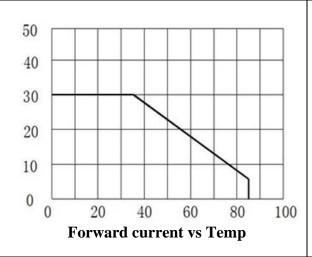
Characteristic Curves

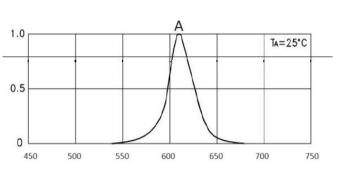


2. 5 2. 0 1. 5 1. 0 0. 5 0 10 20 30 40 50

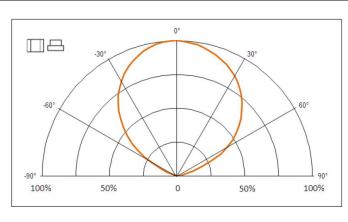
Forward current vs Forward voltage







Spectrum Distribution







■ Reliability test:

No	Item	Condition	Time/Cycle	Sample size
1	Steady State Operating Life of Room Temperature	25 [°] ℂ Operating	1000 Hrs	20 pcs
2	Steady State Operating Life of Low Temperature -40°C	-40°C Operating	1000 Hrs	20 pcs
3	Steady State Operating Life of Low Temperature $60^{\circ}\!$	60°C Operating	1000 Hrs	20 pcs
4	Steady State Operating Life of Low Temperature $85^{\circ}\!\mathbb{C}$	85°C Operating	1000 Hrs	20 pcs
5	Low temperature storage -40°C	-40°C Storage	1000 Hrs	20 pcs
6	High temperature storage 100°C	100°C Storage	1000 Hrs	20 pcs
7	Steady State Operating Life of High Humidity Heat 60°C 90%	60°C/90% Operating	1000 Hrs	20 pcs
8	Steady State Pulse Operating Life Condition	25°C 10Hz duty=1/10 Operating	200 Cycle	20 pcs
9	Resistance to soldering heat on PCB (JEDEC MSL3)	pre-store@60℃, 60%RH for 52hrs Tsld max.=260 10sec	3 Times	20 pcs
10	Heat Cycle Test (JEDEC MRC)	25℃~65℃~-10℃, 90%RH, 24hr/1cycle	10 Cycle	20 pcs
11	Thermal shock	-40°C / 20minr~ 5minr~100°C /20min	300 Cycle	20 pcs

■ Judgment Criteria:

Item	Symbol	Test Condition	Judgment Criteria
Forward Voltage	Vf	JE 50 A	△Vf< 10%
Luminous Flux	lv	IF=50 mA	∆lv< 30%

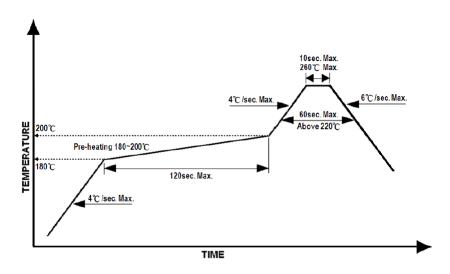




Solder Profile:

- -The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):
- 1. Operating temp.: Above 220 °C ,60 sec.
- 2. Peak temp.:260 °C Max.,10sec Max.
- 3. Reflow soldering should not be done more than two times.
- Never attempt next process until the component is cooled down to room temperature after reflow.
- 5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



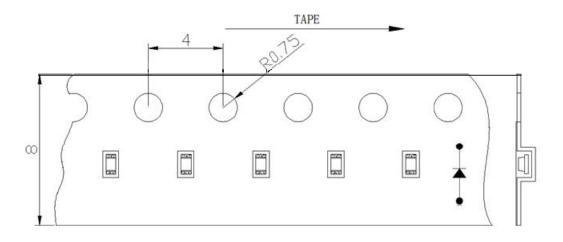
Reworking

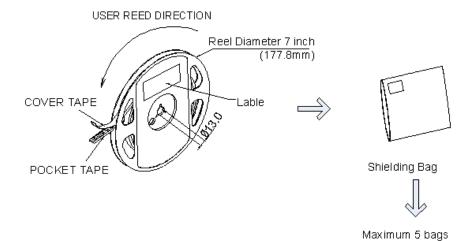
- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

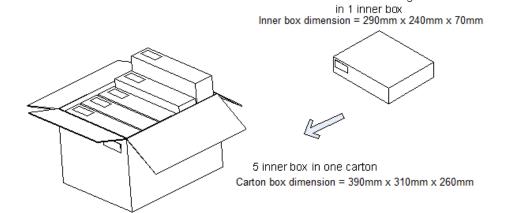




Taping & Packing:











Labeling

Uantity: XXXX

Quelighting P/N: XXXXXX

Lot number: XXXXX

Iv Bin: XX

Color Bin: XX

Vf Bin: XX

Date Code: XXXX

QueLighting

Ordering Information:

Part #	Multiple Quantities	Quantity per Reel
QLSP23A		3000 pcs





Revision History:

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Revision Date:	Changes:	Version #:
01-2023	Initial release	1.0

